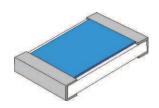


State of the Art, Inc.

M32159/13 Zero Ohm Chip Resistor

Surface Mount, Jumper



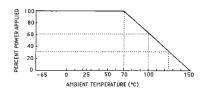
PERFORMANCE

Termination Material	B/G	C	U
Maximum Resistance	0.030 Ω	0.060 Ω	0.150 Ω
Maximum Current	1.1A	0.76A	0.48A
Maximum Power Rating		35 mW	

ENVIRONMENTAL PERFORMANCE

Thermal Shock Low Temperature Operation	Not to exceed maximum value
Short-time Overload	"
Resistance to Bonding Exposure	"
Moisture Resistance	"
High Temperature Exposure	u
Life	u

POWER DERATING



Percentage of power to be applied at various ambient temperatures. Full rated power to 70°, linerarly derated to 0 power at 150°C.

FEATURES

- Operating temperature range : -55° C to +150° C
- Solderable (termination material B) termination pretinned with SN60 over nickel barrier suitable for solder reflow vapor phase or wave solder attachment.
- MIL-PRF-55342 "S" level qualified manufacturer
- Epoxy Bondable terminations available with silver based (C), platinum gold (U) and gold (G) finishes for epoxy attachment.

PRODUCT LEVELS

All product levels are based on the same design. Level C is a Non-Established Reliability part requiring no group A, B or C testing. Military product level M is subject to group A, B and C testing per MIL-PRF-32159. Space product level T requires group A and B tests performed on a production lot basis, including 100% power conditioning.

MECHANICAL	INCHES	MILIMETERS	
Length Width Thickness Top Term Bottom Term Gap Approx. Weight	.032 (.028036) .022 (.017027) .015 (.010025) .005 (.002012) .008 (.003013) .016 (.012020) .00069 grams	0.81 (0.71 - 0.91) 0.56 (0.43 - 0.69) 0.38 (0.25 - 0.51) 0.13 (0.05 - 0.31) 0.20 (0.08 - 0.33) 0.41 (0.31 - 0.51)	

Solderability: (Termination material (B) Solder coating compatible with Sn60, 62 or 63 solders, provides good wetting with all types of solder attachment. All product is tested IAW Mil-Std-202, method 208, including 8 hour steam aging.

PART NUMBERING

M32159 B 13 M

PRODUCT LEVEL DESIGNATOR* M: Military C: Industrial T: Space Level

Size Code: RCZ0302 /13 = 0.030 X 0.020 X 0.012

Termination Material:

- B: Solderable
- C: Silver based epoxy bondable
- G: Gold epoxy bondáble
- U: Pt Au epoxy bondable

PACKAGING

Two packaging options are available:

Waffle Pack - (360 per Tray Max.) Tape & Reel - (5000 per 8" Inch Reel Max.)

OPTIONS

SOTA offers a full line of thick & thin film resistors in the 0302 size including Standard Grade, High-Reliability (customer specified testing). Custom part marking is available.

STATE OF THE ART, INC. 2470 Fox Hill Road, State College, PA 16803-1797 Phone (814) 355-8004 Fax (814) 355-2714 Toll Free 1-800-458-3401